

PCB terminal block - PTSM 0,5/ 3-2,5-H SMDBD1-S3R44 - 1702729

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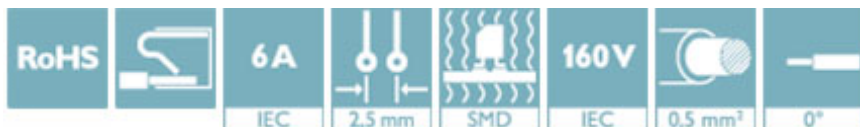


PCB terminal block, nominal current: 6 A, nom. voltage: 160 V, pitch: 2.5 mm, number of positions: 3, connection method: Push-in spring connection, mounting: SMD soldering, conductor/PCB connection direction: 0 °, color: black

The figure shows the 3-pos. version

Your advantages

- ✓ Time saving push-in connection, tools not required
- ✓ Defined contact force ensures that contact remains stable over the long term
- ✓ High current carrying capacity of 6 A in very compact dimensions
- ✓ Designed for integration into the SMT soldering process
- ✓ Additional solder anchors reduce the mechanical strain on the soldering spots



Key Commercial Data

Packing unit	770 pc
GTIN	
GTIN	4046356609760

Technical data

Item properties

Brief article description	PCB terminal block
Range of articles	PTSM 0,5/..-H-SMD
Pitch	2.5 mm
Number of positions	3
Connection method	Push-in spring connection
Mounting type	SMD soldering
Pin layout	Linear pad geometry
Number of levels	1

Electrical parameters

Rated current	6 A
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Technical data

Electrical parameters

Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV

Connection capacity

Conductor cross section solid	0.14 mm ² ... 0.5 mm ²
Conductor cross section flexible	0.2 mm ² ... 0.5 mm ²
Conductor cross section AWG / kcmil	26 ... 20
Conductor cross section flexible, with ferrule without plastic sleeve	0.25 mm ² ... 0.5 mm ²
Stripping length	6 mm

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/ JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	hot-dip tin-plated
Metal surface terminal point (top layer)	Tin (4 - 8 µm Sn)
Metal surface soldering area (top layer)	Tin (4 - 8 µm Sn)

Material data - housing

Insulating material	LCP
Insulating material group	IIIa
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0

Dimensions for the product

Caption	Schematic representation – for additional information, see product range drawing in the Download Center
Length [l]	9 mm
Pitch	2.5 mm
Solder pin [P]	2 mm
Pin spacing	2.5 mm
Dimension a	5 mm

Dimensions for PCB design

Pin spacing	2.5 mm
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Packaging information

Type of packaging	packed in cardboard
Pieces per package	770
Denomination packing units	Pcs.

Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C

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Technical data

Termination and connection method

Connection test	IEC 60998-2-2:2002-12
Test result	Test passed

Pull-out test

Pull-out test	IEC 60998-2-2:2002-12
	Test passed
Conductor cross section / conductor type / tensile force	0.14 mm ² / solid / > 7 N
	0.14 mm ² / flexible / > 7 N
	0.2 mm ² / solid / > 10 N
	0.5 mm ² / solid / > 30 N
	0.75 mm ² / flexible / > 35 N

Mechanical tests according to standard

Test specification	IEC 60998-2-2 (in parts)
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Electrical tests

Rated current	6 A
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV

Air clearances and creepage distances

Insulating material group	IIIa
Voltage	32 V
Rated insulation voltage (III/3)	32 V
Rated insulation voltage (III/2)	160 V
Rated insulation voltage (II/2)	160 V
Rated surge voltage (III/3)	2.5 kV
Rated surge voltage (III/2)	2.5 kV
Rated surge voltage (II/2)	2.5 kV

Current carrying capacity / derating curves

Specification	IEC 60998-2-2 (in parts)
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Vibration test

Resistance to ageing, to humidity conditions, to ingress of solid objects and to harmful ingress of water	Test passed IEC 60998-1:2002-12 168 h/100°C 48 h/30 °C/92 %
Test result	Test passed
Test specification	IEC 60998-1:2002-12
Dry heat	168 h/100°C
Humid heat	48 h/30 °C/92 %

Resistance to ageing, humidity and penetration of solids

Test result	Test passed
Test specification	IEC 60998-1:2002-12
Dry heat	168 h/100°C

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Technical data

Resistance to ageing, humidity and penetration of solids

Humid heat	48 h/30 °C/92 %
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Standards and Regulations

Connection in acc. with standard	EN-VDE
	UL

Environmental Product Compliance

China RoHS	Environmentally friendly use period: unlimited = EFUP-e
	No hazardous substances above threshold values

Approvals

Approvals

Approvals

UL Recognized / VDE Zeichengenehmigung / EAC / cULus Recognized

Ex Approvals

Approval details


UL Recognized		http://database.ul.com/cgi-bin/XYV/template/LISEXT/1FRAME/index.htm	E118976-20130619
			B
Nominal voltage UN			150 V
Nominal current IN			5 A
mm ² /AWG/kcmil			26-18

VDE Zeichengenehmigung		http://www2.vde.com/de/Institut/Online-Service/VDE-gepruefteProdukte/Seiten/Online-Suche.aspx	40048725
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EAC			B.01742
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Approvals

cULus Recognized		http://database.ul.com/cgi-bin/XYV/template/LISEXT/1FRAME/index.htm E60425-20030527
		B
Nominal voltage UN		150 V
Nominal current IN		5 A
mm ² /AWG/kcmil		26-20

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